## **Amendments To The Claims**

The listing of claims will replace all prior versions and listings of claims in the application:

## **Listing of Claims**

Claims 1-41 (cancelled)

Claim 42 (cancelled)

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Claim 43 (originally presented) A process for manufacturing a resonance circuit comprising the steps of:

overlaying an electrically-conductive layer transfer sheet having a thermally transferable electrically-conductive layer on one side of a dielectric material with the thermally transferable electrically-conductive layer facing with the dielectric material surface, and then thermally transferring the thermally transferable electrically-conductive layer on the dielectric material in the predetermined pattern to form a coil-like circuit; and,

overlaying the electrically-conductive layer transfer sheet on the other side of the dielectric material with the thermally transferable electrically-conductive layer facing with the dielectric material surface, and then thermally transferring the thermally transferable electrically-conductive layer on the dielectric material in the predetermined pattern to form a condenser electrode circuit or a coil-like circuit which also serves as a condenser.